



Click [here](#) for the 3D model.

Dimensions

Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
T	1.85mm +/-0.20mm
B	0.5mm +/-0.25mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2000

General Information

Series	SMD Auto COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Automotive Grade
Features	Ultra-Stable, Low Loss, Automotive Grade
RoHS	Yes
Termination	Tin
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Component Weight	70 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.18 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	5.5556 GOhms